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## Getting started with STM32CubeF4 firmware package for STM32F4xx series

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### Introduction

The STM32Cube™ initiative was originated by STMicroelectronics to ease developers life by reducing development efforts, time and cost. STM32Cube™ covers the STM32 portfolio.

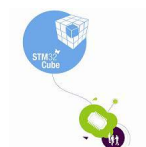
STM32Cube Version 1.x includes:

- The STM32CubeMX, a graphical software configuration tool that allows to generate C initialization code using graphical wizards
- A comprehensive embedded software platform, delivered per series (such as STM32CubeF4 for STM32F4 series)
  - The STM32Cube HAL, an STM32 abstraction layer embedded software, ensuring maximized portability across the STM32 portfolio
  - A consistent set of middleware components such as RTOS, USB, TCP/IP and graphics
  - All embedded software utilities coming with a full set of examples.

This user manual describes how to get started with the STM32CubeF4 firmware package.

[Section 1](#) describes the main features of STM32CubeF4 firmware, part of the STM32Cube™ initiative.

[Section 2](#) and [Section 3](#) provide an overview of the STM32CubeF4 architecture and firmware package structure.



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# 1 STM32CubeF4 main features

STM32CubeF4 gathers together, in a single package, all the generic embedded software components required to develop an application on STM32F4 microcontrollers. In line with the STM32Cube initiative, this set of components is highly portable, not only within the STM32F4 series but also to other STM32 series.

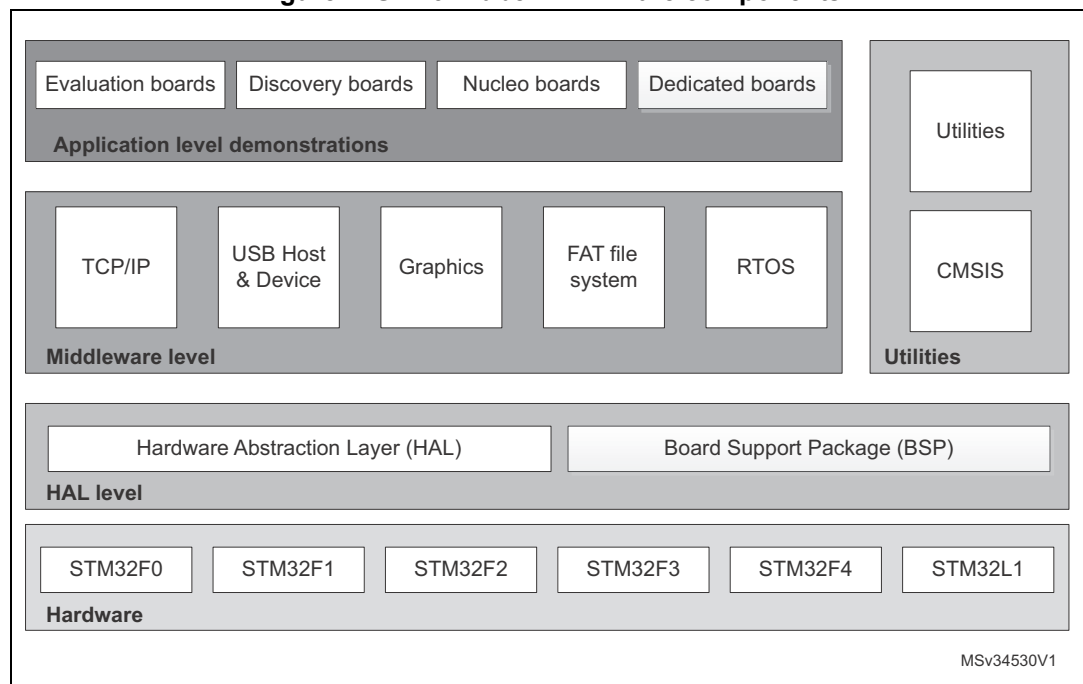
STM32CubeF4 is fully compatible with STM32CubeMX code generator that allows the user to generate initialization code. The package includes a low level hardware abstraction layer (HAL) that covers the microcontroller hardware, together with an extensive set of examples running on STMicroelectronics boards. The HAL is available in an open-source BSD license for user convenience.

STM32CubeF4 package also contains a set of middleware components with the corresponding examples. They come with very permissive license terms:

- Full USB Host and Device stack supporting many classes.
  - Host Classes: HID, MSC, CDC, Audio, MTP
  - Device Classes: HID, MSC, CDC, Audio, DFU
- STemWin, a professional graphical stack solution available in binary format and based on the emWin solution from ST's partner Segger
- CMSIS-RTOS implementation with FreeRTOS open source solution
- FAT File system based on open source FatFS solution
- TCP/IP stack based on open source LwIP solution
- SSL/TLS secure layer based on open source PolarSSL

A demonstration implementing all these middleware components is also provided in the STM32CubeF4 package.

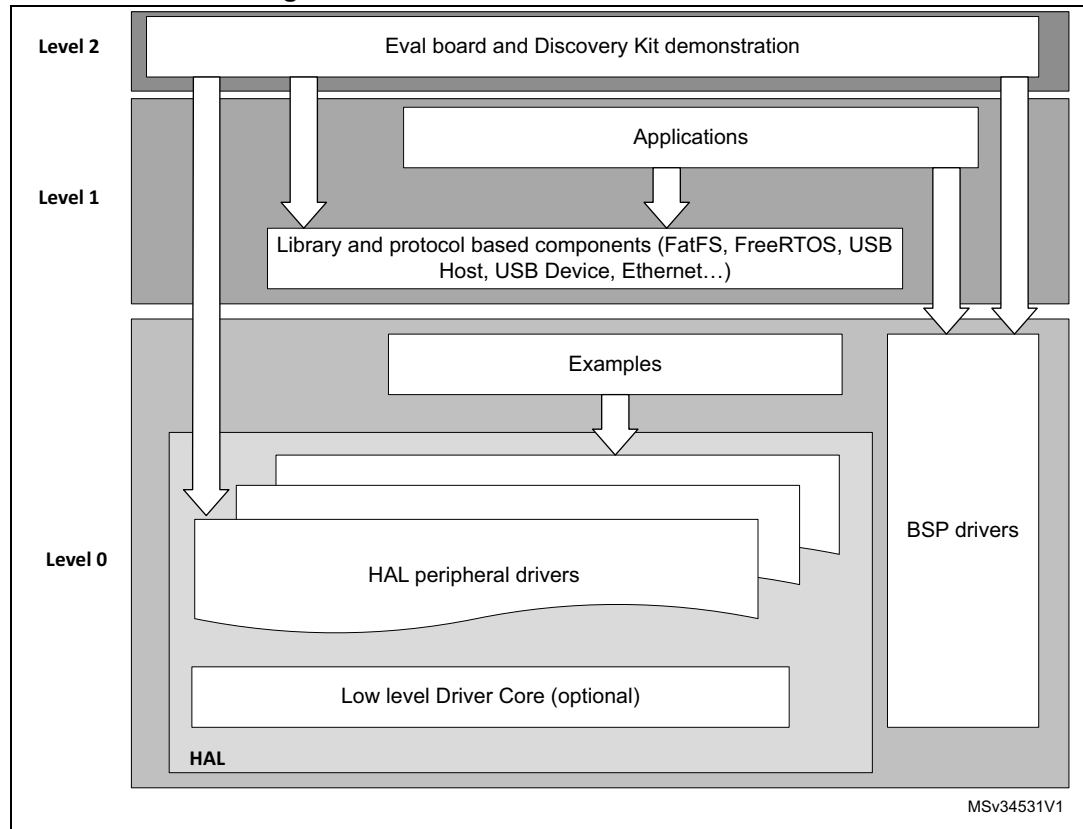
**Figure 1. STM32CubeF4 firmware components**



## 2 STM32CubeF4 architecture overview

The STM32CubeF4 firmware solution is built around three independent levels that can easily interact with each other as described in the [Figure 1](#) below:

**Figure 2. STM32CubeF4 firmware architecture**



**Level 0:** This level is divided into three sub-layers:

- **Board Support Package (BSP):** this layer offers a set of APIs related to the hardware components on the hardware boards (Audio codec, I/O expander, Touchscreen, SRAM driver, LCD drivers. etc...) and composed of two parts:
  - **Component:** is the driver related to the external device on the board and not related to the STM32, the component driver provides specific APIs to the BSP driver's external components and can be ported to any board.
  - **BSP driver:** it enables the component driver to be linked to a specific board and provides a set of user-friendly APIs. The API naming rule is `BSP_FUNCT_Action()`: ex. `BSP_LED_Init()`, `BSP_LED_On()`

It's based on a modular architecture that allows it to be ported easily to any hardware by just implementing the low level routines.

- **Hardware Abstraction Layer (HAL):** this layer provides the low level drivers and the hardware interfacing methods to interact with the upper layers (application, libraries and stacks). It provides generic, multi instance and function-oriented APIs which allow to offload the user application implementation by providing ready-to-use processes. For example, for the communication peripherals (I2S, UART...) it provides APIs allowing to

initialize and configure the peripheral, manage data transfer based on polling, interrupt or DMA process, and manage communication errors that may raise during communication. The HAL Drivers APIs are split in two categories, generic APIs which provides common and generic functions to all the STM32 series and extension APIs which provides specific and customized functions for a specific family or a specific part number.

- **Basic peripheral usage examples:** this layer contains examples of basic operation of the STM32F4 peripherals using only the HAL and BSP resources.

**Level 1:** This level is divided into two sub-layers:

- **Middleware components:** a set of Libraries covering USB Host and Device Libraries, STemWin, FreeRTOS, FatFS, LwIP, and PolarSSL. Horizontal interactions between the components of this layer are done directly by calling the feature APIs while the vertical interaction with the low level drivers is done through specific callbacks and static macros implemented in the library system call interface. For example, the FatFs implements the disk I/O driver to access microSD drive or the USB Mass Storage Class.

The main features of each Middleware component are as follows:

#### USB Host and Device Libraries

- Several USB classes supported (Mass-Storage, HID, CDC, DFU, AUDIO, MTP)
- Supports multi packet transfer features: allows sending big amounts of data without splitting them into max packet size transfers.
- Uses configuration files to change the core and the library configuration without changing the library code (Read Only).
- Includes 32-bit aligned data structures to handle DMA-based transfer in High-speed modes.
- Supports multi USB OTG core instances from user level through configuration file (allows operation with more than one USB host/device peripheral).
- RTOS and Standalone operation
- The link with low-level driver is done through an abstraction layer using the configuration file to avoid any dependency between the Library and the low-level drivers.

#### STemWin Graphical stack

- Professional grade solution for GUI development based on Segger's emWin solution
- Optimized display drivers
- Software tools for code generation and bitmap editing (STemWin Builder...)

#### FreeRTOS

- Open source standard
- CMSIS compatibility layer
- Tickless operation during low-power mode
- Integration with all STM32Cube Middleware modules

FAT File system

- FATFS FAT open source library
- Long file name support
- Dynamic multi-drive support
- RTOS and standalone operation
- Examples with microSD and USB host Mass-storage class

LwIP TCP/IP stack

- Open source standard
- RTOS and standalone operation
- **Examples based on the Middleware components:** each Middleware component comes with one or more examples (called also Applications) showing how to use it. Integration examples that use several Middleware components are provided as well.

**Level 2:** This level is composed of a single layer which is a global real-time and graphical demonstration based on the Middleware service layer, the low level abstraction layer and the applications that make basic use of the peripherals for board-based functions.



## 3 STM32CubeF4 firmware package overview

### 3.1 Supported STM32F4 devices and hardware

STM32Cube offers a highly portable Hardware Abstraction Layer (HAL) built around a generic and modular architecture allowing the upper layers, Middleware and Application, to implement its functions without in-depth knowledge of the MCU being used. This improves the library code re-usability and guarantees an easy portability from one device to another.

The STM32CubeF4 offers full support for all STM32F4 Series devices. You only have to define the right macro in `stm32f4xx.h`.

[Table 1](#) below lists which macro to define depending on the STM32F4 device you are using (this macro can also be defined in the compiler preprocessor).

**Table 1. Macros for STM32F4 series**

Macro defined in <code>stm32f4xx.h</code>	STM32F4 devices
STM32F405xx	STM32F405RG, STM32F405VG and STM32F405ZG
STM32F415xx	STM32F415RG, STM32F415VG and STM32F415ZG
STM32F407xx	STM32F407VG, STM32F407VE, STM32F407ZG, STM32F407ZE, STM32F407IG and STM32F407IE
STM32F417xx	STM32F417VG, STM32F417VE, STM32F417ZG, STM32F417ZE, STM32F417IG and STM32F417IE
STM32F427xx	STM32F427VG, STM32F427VI, STM32F427ZG, STM32F427ZI, STM32F427IG and STM32F427II
STM32F437xx	STM32F437VG, STM32F437VI, STM32F437ZG, STM32F437ZI, STM32F437IG and STM32F437II
STM32F429xx	STM32F429VG, STM32F429VI, STM32F429ZG, STM32F429ZI, STM32F429BG, STM32F429BI, STM32F429NG, STM32F439NI, STM32F429IG and STM32F429II
STM32F439xx	STM32F439VG, STM32F439VI, STM32F439ZG, STM32F439ZI, STM32F439BG, STM32F439BI, STM32F439NG, STM32F439NI, STM32F439IG and STM32F439II
STM32F401xC	STM32F401CB, STM32F401CC, STM32F401RB, STM32F401RC, STM32F401VB and STM32F401VC
STM32F401xE	STM32F401CD, STM32F401RD, STM32F401VD, STM32F401CE, STM32F401RE, STM32F401VE

STM32CubeF4 features a rich set of examples and demonstrations at all levels making it easy to understand and use any HAL driver and/or Middleware components. These

examples can be run on any of the STMicroelectronics boards as listed in [Table 2](#) below:

**Table 2. Evaluation and Discovery boards for STM32F4 series**

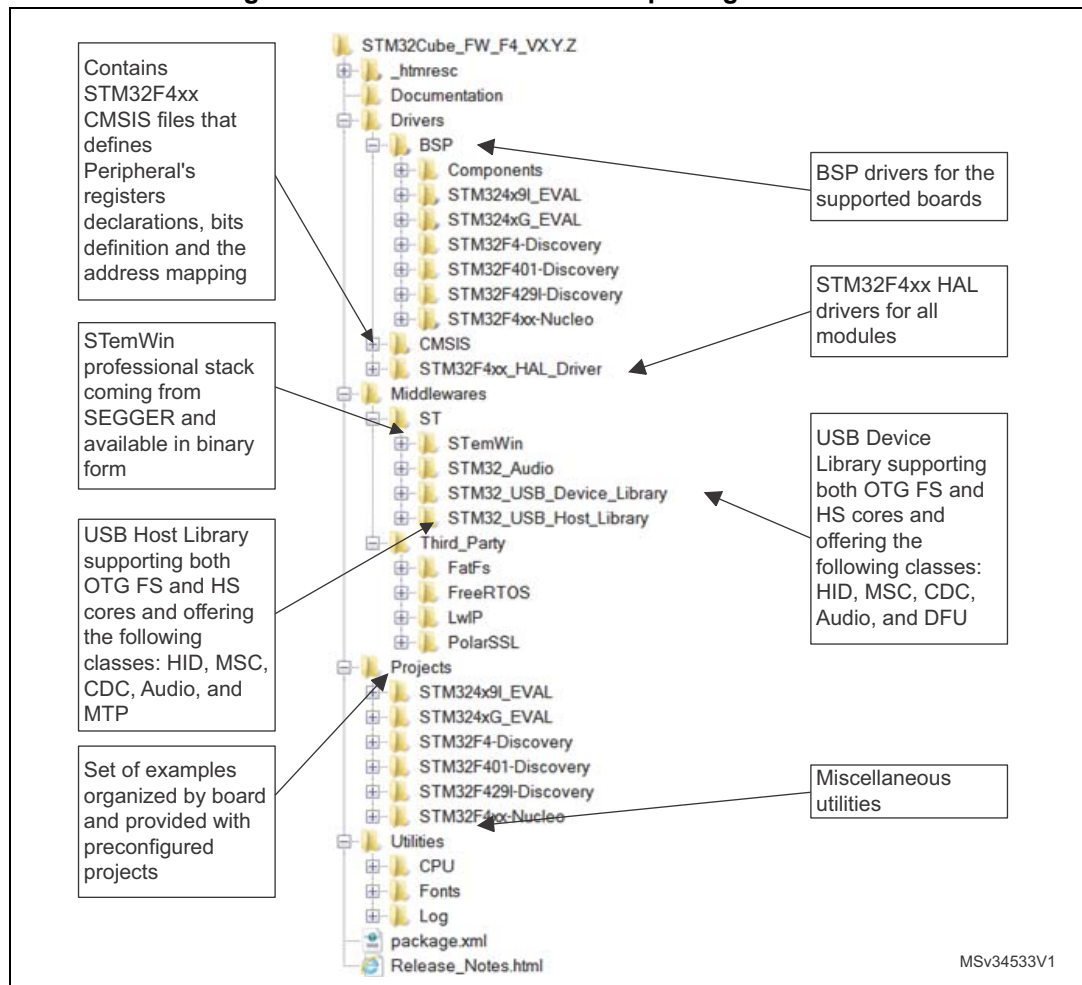
Board	STM32F4 devices supported
STM324x9I_EVAL	STM32F429xx and STM32F439xx
STM324xG_EVAL	STM32F407xx and STM32F417xx
STM32F4-Discovery	STM32F407xx
STM32F401-Discovery	STM32F401xC
STM32F429I-Discovery	STM32F429xx
STM32F4xx-Nucleo	STM32F401xE

The STM32CubeF4 firmware is able to run on any compatible hardware. This means you can simply update the BSP drivers to port the provided examples to your own board, if it has the same hardware functions (LED, LCD display, pushbuttons...etc.).

## 3.2 Firmware package overview

The STM32CubeF4 firmware solution is provided in a single zip package with the structure shown in [Figure 3](#) below.

Figure 3. STM32CubeF4 firmware package structure



For each board, a set of examples are provided with preconfigured projects for EWARM, MDK-ARM and TrueSTUDIO toolchains.

[Figure 4](#) shows the project structure for the STM324xG-EVAL board. The structure is identical for other boards.

The examples are classified depending on the STM32Cube level they apply to, and are named as follows:

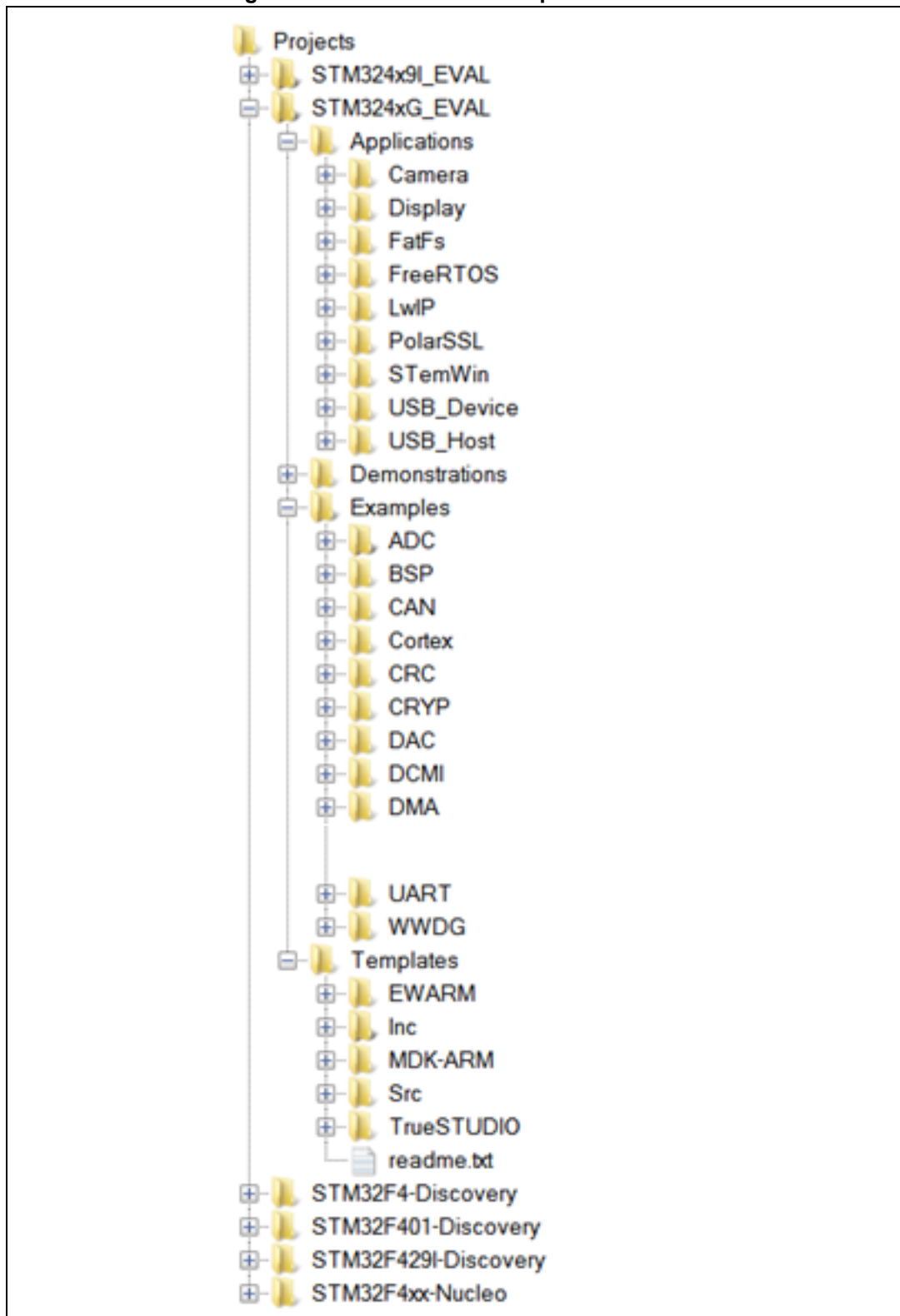
- Examples in level 0 are called Examples, that use HAL drivers without any Middleware component
- Examples in level 1 are called Applications, that provide typical use cases of each Middleware component
- Examples in level 2 are called Demonstration, that implement all the HAL, BSP and Middleware components

A Template project is provided to allow you to quickly build any firmware application on a given board.

All examples have the same structure,

- \Inc folder that contains all header files
- \Src folder for the sources code
- \EWARM, \MDK-ARM and \TrueSTUDIO folders contain the preconfigured project for each toolchain.
- readme.txt describing the example behavior and the environment required to make it work

Figure 4. STM32CubeF4 examples overview



[Table 3](#) provides the number of examples, applications and demonstrations available for each board.

**Table 3. Number of examples available for each board**

Board	Examples	Applications	Demonstration
STM324x9I_EVAL	83	56	1
STM324xG_EVAL	68	52	1
STM32F4-Discovery	22	4	1
STM32F401-Discovery	20	4	1
STM32F429I-Discovery	26	8	1
STM32F4xx-Nucleo	3	NA	NA

## 4 Getting started

### 4.1 How to run your first example

This section explains how simple it is to run a first example with STM32CubeF4. As an illustration let's consider to run a simple LED toggling example running on the STM32F4-Discovery board:

1. After downloading the STM32CubeF4 firmware package, unzip it into a directory of your choice, you just need to ensure that the package structure is not modified (as shown in [Figure 3](#) above).
2. Browse to \Projects\STM32F4-Discovery\Examples.
3. Open \GPIO, then the \GPIO\_EXTI folder.
4. Open the project with your preferred toolchain.
5. Rebuild all files and load your image into target memory.
6. Run the example: each time you press User button 4, the LEDs will toggle (for more details, refer to the example readme file).

You will get a quick overview of how to open, build and run an example with the supported toolchains.

- EWARM
  - Under the example folder, open the \EWARM subfolder
  - Open the Project.eww workspace<sup>(a)</sup>
  - Rebuild all files: Project->Rebuild all
  - Load project image: Project->Debug
  - Run program: Debug->Go(F5)
- MDK-ARM
  - Under the example folder, open the \MDK-ARM subfolder
  - Open the Project.uvproj workspace<sup>(a)</sup>
  - Rebuild all files: Project->Rebuild all target files
  - Load project image: Debug->Start/Stop Debug Session
  - Run program: Debug->Run (F5)
- TrueSTUDIO
  - Open the TrueSTUDIO toolchain
  - Click on File->Switch Workspace->Other and browse to the TrueSTUDIO workspace directory
  - Click on File->Import, select General->'Existing Projects into Workspace' and then click "Next".
  - Browse to the TrueSTUDIO workspace directory, select the project
  - Rebuild all project files: Select the project in the "Project explorer" window then click on Project->build project menu.
  - Run program: Run->Debug (F11)

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a. The workspace name may change from one example to another

## 4.2 How to develop your own application

This section describes the required steps needed to create your own application using STM32CubeF4.

1. **Create your project:** to create a new project you can either start from the Template project provided for each board under \Projects\<STM32xx\_xxx>\Templates or from any available project under \Projects\<STM32xx\_xxx>\Examples or \Projects\<STM32xx\_xxx>\Applications (<STM32xx\_xxx> refers to the board name, ex. STM32F4-Discovery).

The Template project provides an empty main loop function, this is a good starting point to allow you to get familiar with the project settings for STM32CubeF4. It has the following characteristics:

- a) It contains sources of the HAL, CMSIS and BSP drivers which are the minimum required components to develop code for a given board
- b) It contains the include paths for all the firmware components
- c) It defines the STM32F4 device supported, allowing to have the right configuration for the CMSIS and HAL drivers
- d) It provides ready-to-use user files preconfigured as follows:
  - HAL is initialized
  - SysTick ISR implemented for HAL\_Delay() purpose
  - System clock is configured with the maximum frequency of the device

*Note: If you copy an existing project to another location, then you need to update the include paths.*

2. **Add the necessary Middleware to your project (optional):** available Middleware stacks are: USB Host and Device Libraries, STemWin, FreeRTOS, FatFS, LwIP, and PolarSSL. To find out which source files you need to add to the project files list, refer to the documentation provided for each Middleware, you can also have a look at the applications available under \Projects\STM32xx\_xxx\Applications\<MW\_Stack> (<MW\_Stack> refers to the Middleware stack, for example USB\_Device) to get a better idea of the source files to be added and the include paths.
3. **Configure the firmware components:** the HAL and Middleware components offer a set of build time configuration options using macros declared with “#define” in a header file. A template configuration file is provided within each component, which you have to copy to the project folder (usually the configuration file is named xxx\_conf\_template.h. The word “\_template” needs to be removed when copying it to the project folder). The configuration file provides enough information to know the effect of each configuration option. More detailed information is available in the documentation provided for each component.
4. **Start the HAL Library:** after jumping to the main program, the application code needs to call HAL\_Init() API to initialize the HAL Library, which does the following:
  - a) Configures the Flash prefetch, instruction and data caches (user-configurable by macros defined in stm32f4xx\_hal\_conf.h)
  - b) Configures the SysTick to generate an interrupt each 1 msec, which is clocked by the HSI (at this stage, the clock is not yet configured and thus the system is running from the internal HSI at 16 MHz)
  - c) Sets NVIC Group Priority to 4
  - d) Calls the HAL\_MspInit() callback function defined in user file stm32f4xx\_hal\_msp.c to do the global low level hardware initialization



5. **Configure the system clock:** the system clock configuration is done by calling these two APIs
  - a) `HAL_RCC_OscConfig()`: configures the internal and/or external oscillators, PLL source and factors. You can choose to configure one oscillator or all oscillators. You can also skip the PLL configuration if there is no need to run the system at high frequency
  - b) `HAL_RCC_ClockConfig()`: configures the system clock source, Flash latency and AHB and APB prescalers
6. **Develop your application process:** at this stage, your system is ready and you can start developing your application code.
  - a) The HAL provides intuitive and ready-to-use APIs for configuring the peripheral, and supports polling, interrupt and DMA programming models, to accommodate any application requirements. For more details on how to use each peripheral, refer to the rich examples set provided.
  - b) If your application has some real-time constraints, you can find a large set of examples showing how to use FreeRTOS and integrate it with all Middleware stacks provided in STM32CubeF4, it can be a good starting point for your development.
  - c) **IMPORTANT NOTE:** care must be taken when using `HAL_Delay()`. This function provides an accurate delay (in milliseconds) based on a variable incremented in SysTick ISR. This implies that if `HAL_Dely()` is called from a peripheral ISR process, then the SysTick interrupt must have the highest priority (numerically lower) than the peripheral interrupt. Otherwise the caller ISR process will be blocked. To change the SysTick interrupt priority, you have to use the `HAL_NVIC_SetPriority()` function.

### 4.3 Using STM32CubeMX for generating the initialization C code

Another alternative to Steps 1 to 5 described in [Section 4.2](#) consists in using the STM32CubeMX tool to easily generate code for the initialization of the system, the peripherals and middleware (Steps 1 to 5 above) through a step-by-step process:

- Selection of the STMicroelectronics STM32 microcontroller that matches the required set of peripherals.
- Configuration of each required embedded software thanks to a pinout-conflict solver, a clock-tree setting helper, a power consumption calculator, and an utility performing MCU peripheral configuration (GPIO, USART...) and middleware stacks (USB, TCP/IP...).
- Generation of the initialization C code based on the configuration selected. This code is ready to be used within several development environments. The user code is kept at the next code generation.

For more information, please refer to UM1718.

## 4.4 How to get STM32CubeF4 release updates

The STM32CubeF4 firmware package comes with an updater utility: STM32CubeUpdater, also available as a menu within STM32CubeMX code generation tool.

The updater solution detects new firmware releases and patches available from st.com and proposes to download them to the user's computer.

### 4.4.1 How to install and run the STM32CubeUpdater program

- Double-click SetupSTM32CubeUpdater.exe file to launch the installation.
- Accept the license terms and follow the different installation steps.

Upon successful installation, STM32CubeUpdater becomes available as an STMicroelectronics program under Program Files and is automatically launched.

The STM32CubeUpdater icon appears in the system tray:



- Right-click the updater icon and select Updater Settings to configure the Updater connection and whether to perform manual or automatic checks (see STM32CubeMX User guide - UM1718 section 3 - for more details on Updater configuration).

## 5 FAQ

### **What is the license scheme for the STM32CubeF4 firmware?**

The HAL is distributed under a non-restrictive BSD (Berkeley Software Distribution) license.

The Middleware stacks made by ST (USB Host and Device Libraries, STemWin) come with a licensing model allowing easy reuse, provided it runs on an ST device.

The Middleware based on well-known open-source solutions (FreeRTOS, FatFs, LwIP and PolarSSL) have user-friendly license terms. For more details, refer to the license agreement of each Middleware.

### **What boards are supported by the STM32CubeF4 firmware package?**

The STM32CubeF4 firmware package provides BSP drivers and ready-to-use examples for the following STM32F4 boards: STM324x9I\_EVAL, STM324xG\_EVAL, STM32F4-Discovery, STM32F401-Discovery, STM32F429I-Discovery, STM32F4xx-Nucleo.

### **Is there any link with Standard Peripheral Libraries?**

The STM32Cube HAL Layer is the replacement of the Standard Peripheral Library.

The HAL APIs offer a higher abstraction level compared to the standard peripheral APIs. HAL focuses on peripheral common functionalities rather than hardware. The higher abstraction level allows to define a set of user friendly APIs that can be easily ported from one product to another.

Customers currently using Standard Peripheral Libraries will be helped through Migration guides. Existing Standard Peripheral Libraries will be supported, but not recommended for new designs.

### **Does the HAL take benefit from interrupts or DMA? How can this be controlled?**

Yes. The HAL supports three API programming models: polling, interrupt and DMA (with or without interrupt generation).

### **Are any examples provided with the ready-to-use toolset projects?**

Yes. STM32CubeF4 provides a rich set of examples and applications (140 for STM324x9I\_EVAL). They come with the preconfigured project of several toolsets: IAR, Keil and GCC.

### **How are the product/peripheral specific features managed?**

The HAL offers extended APIs, i.e. specific functions as add-ons to the common API to support features available on some products/lines only.

### **How can STM32CubeMX generate code based on embedded software?**

STM32CubeMX has a built-in knowledge of STM32 microcontrollers, including their peripherals and software. This enables the tool to provide a graphical representation to the user and generate \*.h/\*.c files based on user configuration.

**How to get regular updates on the latest STM32CubeF4 firmware releases?**

The STM32CubeF4 firmware package comes with an updater utility, STM32CubeUpdater, that can be configured for automatic or on-demand checks for new firmware package updates (new releases or/and patches).

STM32CubeUpdater is integrated as well within the STM32CubeMX tool. When using this tool for STM32F4 configuration and initialization C code generation, the user can benefit from STM32CubeMX self-updates as well as STM32CubeF4 firmware package updates.

For more details, refer to [Section 4.4](#).

## 6 Revision history

**Table 4. Document revision history**

Date	Revision	Changes
17-Feb-2014	1	Initial release.

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